

Silicon Carbide (SiC) MOSFET - EliteSiC, 57 mohm, 650 V, M2, TO-247-4L

NTH4L075N065SC1

Features

- Typ. $R_{DS(on)} = 57 \text{ m}\Omega$ @ $V_{GS} = 18 \text{ V}$ Typ. $R_{DS(on)} = 75 \text{ m}\Omega$ @ $V_{GS} = 15 \text{ V}$
- Ultra Low Gate Charge (Q_{G(tot)} = 61 nC)
- Low Output Capacitance (Coss = 107 pF)
- 100% Avalanche Tested
- $T_J = 175^{\circ}C$
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb-Free 2LI (on second level interconnection)

Typical Applications

- SMPS (Switching Mode Power Supplies)
- Solar Inverters
- UPS (Uninterruptable Power Supplies)
- Energy Storages

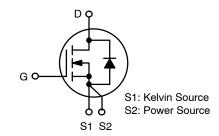
MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	650	V
Gate-to-Source Voltage	ı		V_{GS}	-8/+22	V
Recommended Operation Values of Gate-to-Source Voltage		V_{GSop}	-5/+18	>	
Continuous Drain Current (Note 1)	Steady State	T _C = 25°C	I _D	38	Α
Power Dissipation (Note 1)			P _D	148	W
Continuous Drain Current (Note 1)	Steady State T _C = 100°C		I _D	26	Α
Power Dissipation (Note 1)			P _D	74	W
Pulsed Drain Current (Note 2)	T _C = 25°C		I _{DM}	120	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			I _S	29	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 12.9 A, L = 1 mH) (Note 3)			E _{AS}	83	mJ
Maximum Lead Temperature for Soldering (1/8" from case for 5 s)			TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Repetitive rating, limited by max junction temperature.
- 3. E_{AS} of 83 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 12.9 A, V_{DD} = 50 V, V_{GS} = 18 V.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
650 V	85 mΩ @ 18 V	38 A

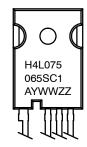


N-CHANNEL MOSFET



TO-247-4LD CASE 340CJ

MARKING DIAGRAM



H4L075065SC1 = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping	
NTH4L075N065SC1	TO-247-4LD	30 Units / Tube	

Table 1. THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case - Steady State (Note 1)	$R_{ heta JC}$	1.01	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	40	

Table 2. ELECTRICAL CHARACTERISTICS (T. J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u> </u>				1		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 mA		650	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 20 mA, referenced to 25°C		-	0.15	-	V/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25°C	-	_	10	μΑ
		V _{DS} = 650 V	T _J = 175°C	-	_	1	mA
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = +18/-5 \text{ V}, V_{DS}$	= 0 V	-	_	250	nA
ON CHARACTERISTICS (Note 2)	•				•		
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 5 \text{ mA}$		1.8	2.8	4.3	V
Recommended Gate Voltage	V_{GOP}			-5	_	+18	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 15 V, I _D = 15 A,	T _J = 25°C	-	75	-	mΩ
		V _{GS} = 18 V, I _D = 15 A,	T _J = 25°C	-	57	85	
		V _{GS} = 18 V, I _D = 15 A,	T _J = 175°C	-	68	-	
Forward Transconductance	9 _{FS}	V _{DS} = 10 V, I _D = 15 A		-	9	-	S
CHARGES, CAPACITANCES & GATE RES	SISTANCE				I	<u> </u>	I
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 325 V		-	1196	-	pF
Output Capacitance	C _{OSS}			_	107	_	
Reverse Transfer Capacitance	C _{RSS}			-	9	-	
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -5/18 \text{ V}, V_{DS} = 520 \text{ V},$ $I_{D} = 15 \text{ A}$ $f = 1 \text{ MHz}$		-	61	_	nC
Gate-to-Source Charge	Q _{GS}			-	19	-	
Gate-to-Drain Charge	Q_{GD}			-	18	-	
Gate-Resistance	R _G			-	5.8	-	Ω
SWITCHING CHARACTERISTICS	•	•			1	1	
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -5/18 \text{ V}, V_{DS} =$	400 V,	-	10	-	ns
Rise Time	t _r	I_D = 15 A, R_G = 2.2 Ω Inductive load		-	12	_	
Turn-Off Delay Time	t _{d(OFF)}	1		-	20	-	
Fall Time	t _f	1		-	7	-	
Turn-On Switching Loss	E _{ON}			_	38	_	μJ
Turn-Off Switching Loss	E _{OFF}			-	16	_	
Total Switching Loss	E _{tot}			-	54	-	
DRAIN-SOURCE DIODE CHARACTERIST	ics	•		•			
Continuous Drain-Source Diode Forward Current	I _{SD}	$V_{GS} = -5 \text{ V}, T_{J} = 25^{\circ}\text{C}$;	_	-	29	А
Pulsed Drain-Source Diode Forward Current (Note 2)	I _{SDM}			_	-	120	
Forward Diode Voltage	V _{SD}	V _{GS} = -5 V, I _{SD} = 15 A	A, T _J = 25°C	-	4.4	_	V

Table 2. ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified) (continued)

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Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
DRAIN-SOURCE DIODE CHARACTERIS	DRAIN-SOURCE DIODE CHARACTERISTICS							
Reverse Recovery Time	t _{RR}	V _{GS} = -5/18 V, I _{SD} = 15 A, dI _S /dt = 1000 A/μs	-	16	-	ns		
Reverse Recovery Charge	Q_{RR}	αι _S /αt = 1000 A/μs	-	72	-	nC		
Reverse Recovery Energy	E _{REC}		-	7.4	-	μJ		
Peak Reverse Recovery Current	I _{RRM}		_	9	-	Α		
Charge Time	Ta		-	9	-	ns		
Discharge Time	Tb		-	7	-	ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

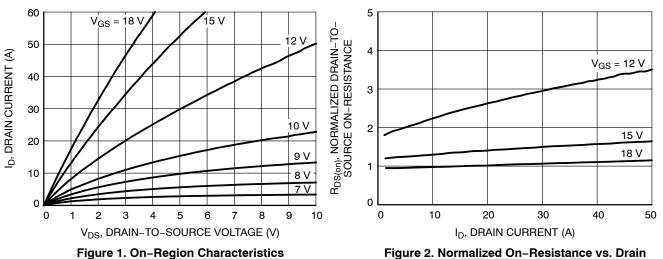
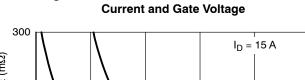


Figure 1. On-Region Characteristics



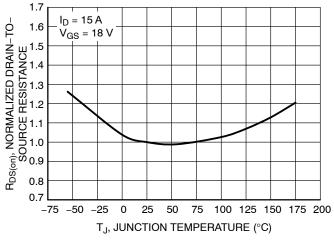


Figure 3. On-Resistance Variation with Temperature

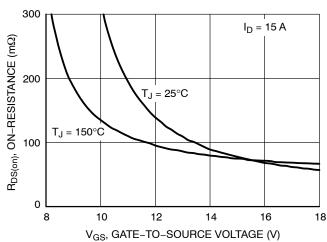


Figure 4. On-Resistance vs. Gate-to-Source Voltage

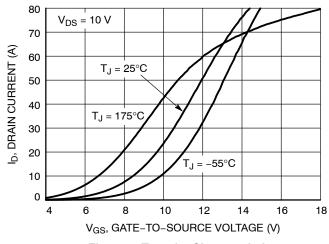


Figure 5. Transfer Characteristics

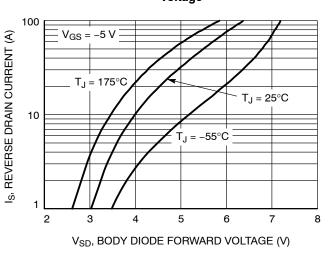
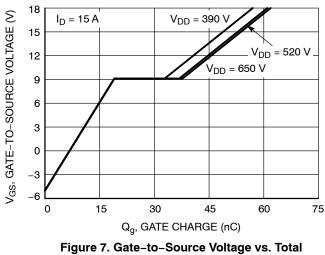


Figure 6. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS (CONTINUED)

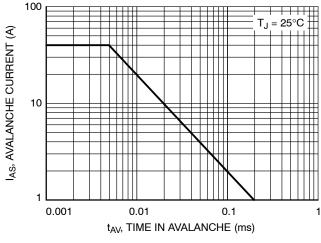
10000



Ciss 1000 CAPACITANCE (pF) 100 10 f = 1 MHz $V_{GS} = 0 V$ 1 10 650 0.1 100 V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

Charge

Figure 8. Capacitance vs. Drain-to-Source Voltage



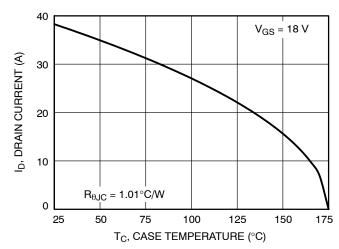
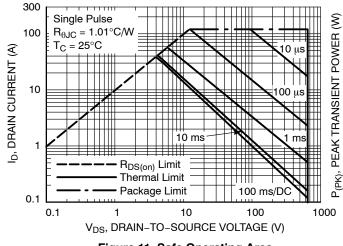


Figure 9. Unclamped Inductive Switching Capability

Figure 10. Maximum Continuous Drain **Current vs. Case Temperature**



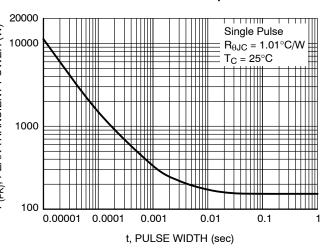


Figure 11. Safe Operating Area

Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (CONTINUED)

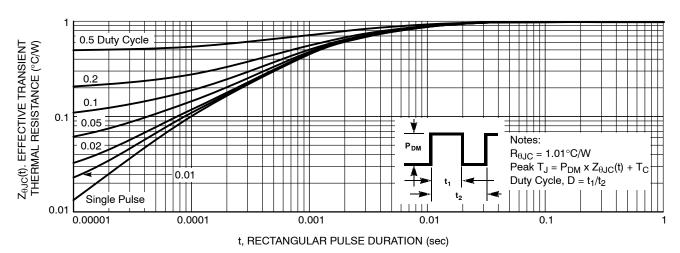


Figure 13. Junction-to-Case Thermal Response

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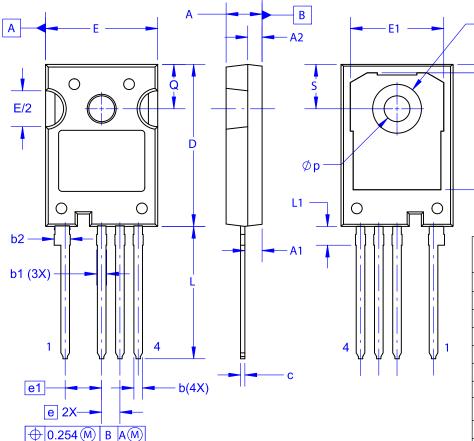
D1

D2



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019



NOTES:

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
 B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
 FLASH, AND TIE BAR EXTRUSIONS.
 C. ALL DIMENSIONS ARE IN MILLIMETERS.
 D. DRAWING CONFORMS TO ASME Y14.5-2009.

DIM	MILLIMETERS					
DIM	MIN	NOM	MAX			
Α	4.80	5.00	5.20			
A1	2.10	2.40	2.70			
A2	1.80	2.00	2.20			
b	1.07	1.20	1.33			
b1	1.20	1.40	1.60			
b2	2.02	2.22	2.42			
С	0.50	0.60	0.70			
D	22.34	22.54	22.74			
D1	16.00	16.25	16.50			
D2	0.97	1.17	1.37			
е	2.54 BSC					
e1	5	5.08 BSC				
E	15.40	15.60	15.80			
E1	12.80	13.00	13.20			
E/2	4.80	5.00	5.20			
L	18.22	18.42	18.62			
L1	2.42	2.62	2.82			
р	3.40	3.60	3.80			
p1	6.60	6.80	7.00			
Q	5.97	6.17	6.37			
S	5.97	6.17	6.37			

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